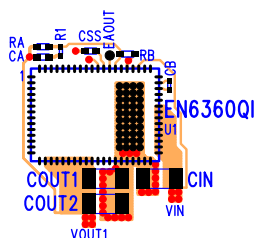




For best thermal performance,  
Make GND copper as large as  
possible, except on layer 1  
directly under U1.



All footprints and spacings have been set  
according to common PCB fabrication  
and assembly practices. If necessary,  
these spacings can be modified according to  
customer manufacturing capabilities.

#### EN6360QI Critical Component Circuit

This layout shows the critical components  
and traces for minimum footprint with ENABLE  
tied to Vin and pre-biased startup enabled.  
Alternate ENABLE and pre-bias configurations, & other  
low-power pins need to be connected and routed  
according to the customer application.

Solder mask and paste layer openings should be  
reviewed and optimized to meet customer  
PCB fabrication and assembly guidelines.

Gerber Format: RS274X, 3.5  
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